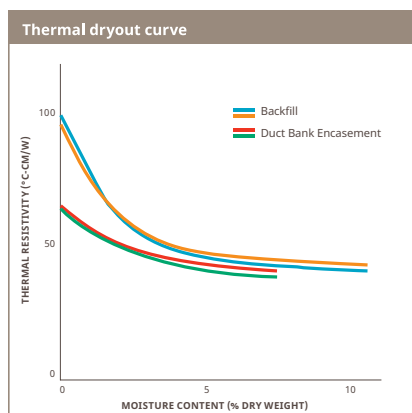


Thermaflow™

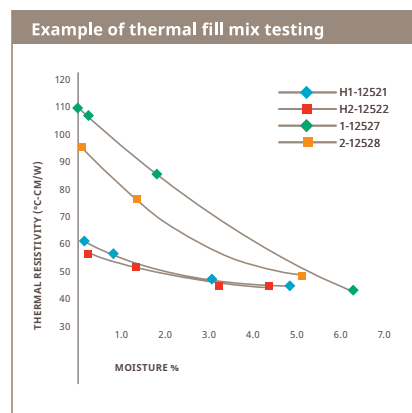
Optimizes the design of duct-bank systems for predictable thermal performance and potential project cost savings.

FEATURES:

- Thermaflow™ thermal fill is an innovative fill material that dissipates heat generated by buried cables supplying electrical power to data centers and other high demand facilities.
- Superior thermal performance may allow optimization of conduit capacity and trench design, resulting in reductions in material cost and back fill labor.
- Thermaflow™ is available in a range of strengths and levels of thermal resistivity (Rho value).
- Pretested and third party verified for predictable material performance.
- Flowability and small aggregate size allow the material to flow into all of the spaces in tight conduit runs.
- Each mix is engineered using local materials to ensure the project gets the material performance needed.



Science that Performs
Material science expertise delivers thermal value/moisture.

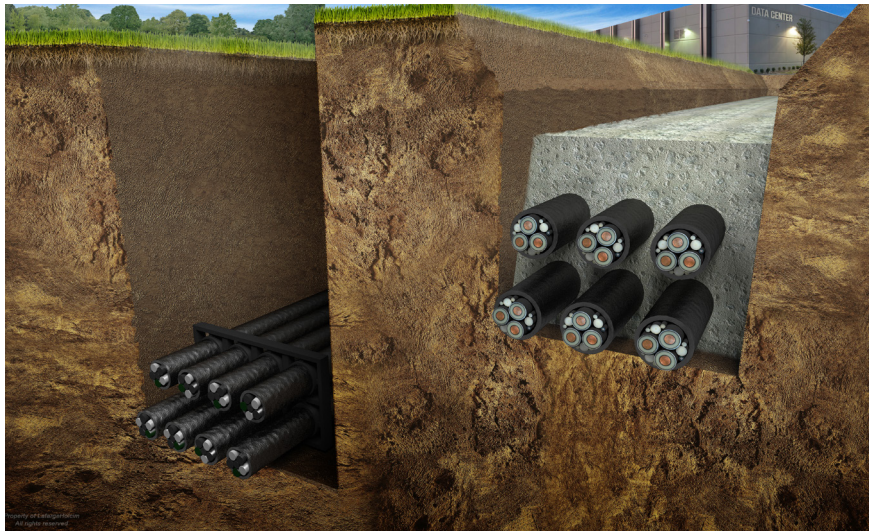


Performance Tested
Internal testing capability coupled with third party verification ensures predictable material performance.

Thermaflow™

When a creative project requires specific products and applications, let Lafarge's knowledge and experience make the process as easy as possible.

Thermaflow optimizes the design of duct bank systems for predictable thermal performance.



Thermaflow™ enables optimization of duct bank design for cost savings.

ADDITIONAL INFORMATION:

- Conduit/cable capacity may allow for faster construction.
- May allow for shallower trench designs for reduced excavation and backfill cost.
- Everything batched at the plant. No need to add anything at the job site.